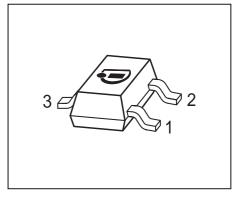


BF771

NPN Silicon RF Transistor

- For modulators and amplifiers in TV and VCR tuners
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BF771	RBs	1 = B	2 = E	3 = C	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	12	V
Collector-emitter voltage	V _{CES}	20	
Collector-base voltage	V _{CBO}	20	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	80	mA
Base current	I _B	10	
Total power dissipation ²⁾	P _{tot}	580	mW
<i>T</i> _S ≤ 69°C			
Junction temperature	T _i	150	°C
Ambient temperature	T _A	-65 150	
Storage temperature	T _{stg}	-65 150	
The second Development			•

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ³⁾	R _{thJS}	≤ 140	K/W

¹Pb-containing package may be available upon special request

 $^2\mathcal{T}_{\mbox{S}}$ is measured on the collector lead at the soldering point to the pcb

³For calculation of R_{thJA} please refer to Application Note Thermal Resistance



Parameter	Symbol	Values			Unit
		min.	typ.	max.]
DC Characteristics				•	
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
$V_{\rm CE} = 20 \text{ V}, \ V_{\rm BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB} = 1 \text{V}, I_{\rm C} = 0$					
DC current gain-	h _{FE}	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at $T_A = 25^{\circ}C$, unless otherwise specified

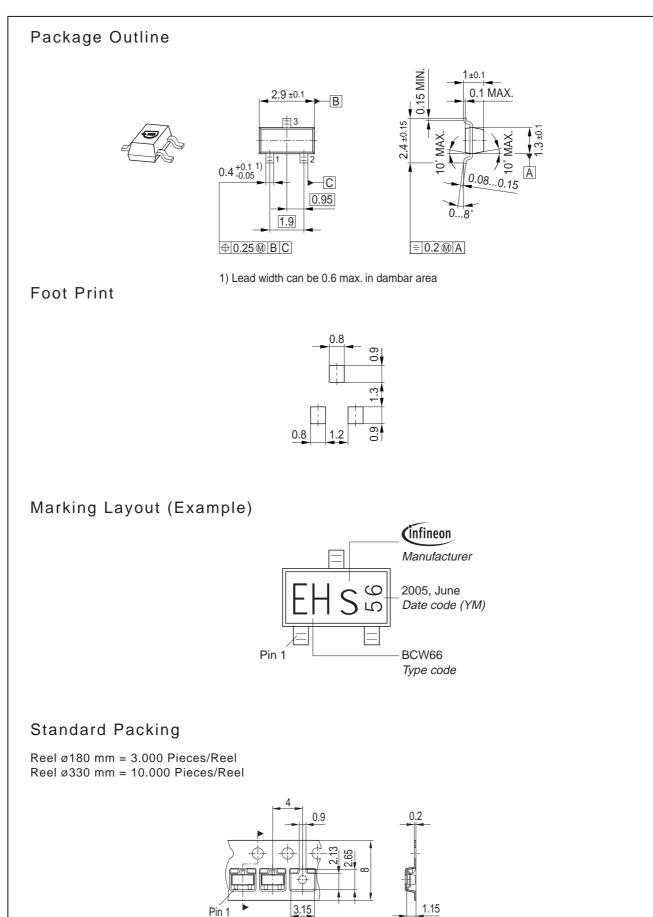


Parameter	Symbol		Values		Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	1	1		1
Transition frequency	f _T	6	8	-	GHz
$I_{\rm C} = 50 \text{ mA}, V_{\rm CE} = 8 \text{ V}, f = 500 \text{ MHz}$					
Collector-base capacitance	C _{cb}	-	0.66	1	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.28	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	2.25	-	
$V_{\rm EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\rm CB} = 0$,					
collector grounded					
Noise figure	F				dB
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 900 MHz		-	1	-	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 1.8 GHz		-	1.6	-	
Power gain, maximum available ¹⁾	G _{ma}				
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 900 {\rm MHz}$		-	15	-	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 1.8 {\rm GHz}$		-	10	-	
Transducer gain	S _{21e} ²				dB
$I_{\rm C} = 30 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \Omega$,					
<i>f</i> = 900 MHz		-	13	-	
$I_{\rm C} = 30 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \Omega$,					
<i>f</i> = 1.8 GHz		-	7.5	-	

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 ${}^{1}G_{\text{ma}} = |S_{21} / S_{12}| \ (\text{k-}(\text{k}^{2}-1)^{1/2})$





Pin 1



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